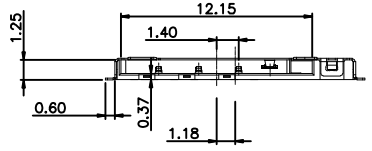
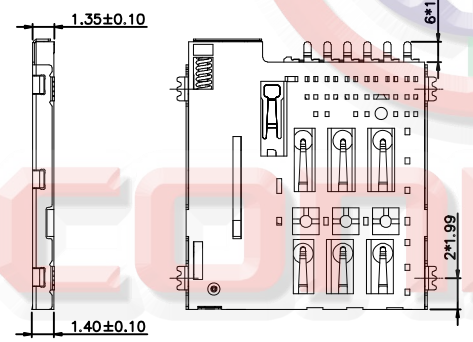
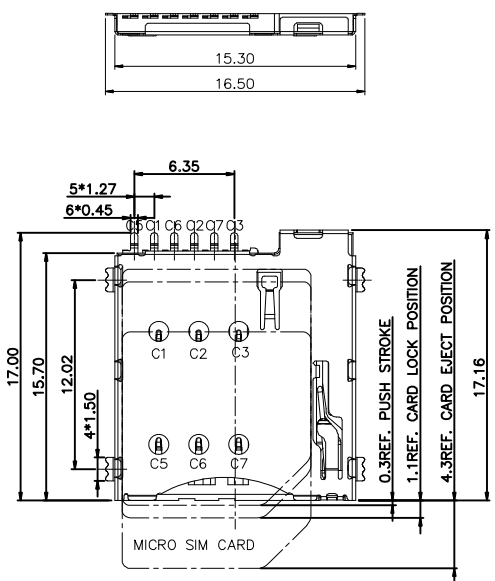


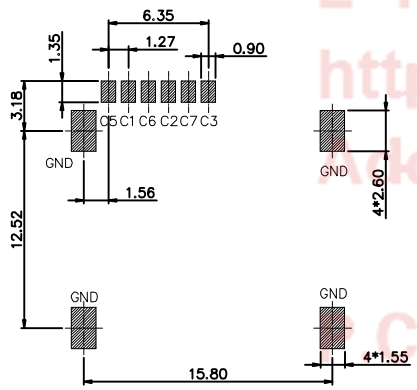
REV.	DESCRIPTION	DRAWN	CHECKED	APPROVED
A	NEW RELEASE	JLZ 10/31/17'		

Notes:
1.Material:
 1.1. Housing: High Temperature UL 94V-0.
 1.2. Contacts: Copper Alloy. Selective Gold Flash.
 1.3. Shell:Stainless Steel.
2.Specifications:
 2.1. Operate Temperature: -20° C~+85° C
 2.2. Insulation Resistance: 100MΩ Min.
 2.3. Contact Resistance: 50mΩ max.
 2.4. Withstanding Voltage: 500V AC 1min.
 2.5. Voltage Rating: 30V AC/DC
 2.6. Current Rating: 0.5A
3.Product Number Code:
 DS1138-11 - XX X X X X X - N - 109

Packing Type
 R: Tape On Reel
 Housing color
 B: Black
 Contact Plating
 0: Selective gold flash
 Mounting type
 S: SMT type
 Connector type
 S: Socket
 No. of contacts
 06:6pin



IN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



■ SMT SOLDER AREA
 THERE SHOULD NOT BE ANY CIRCUITRIES
 IN THE LAYOUT SPACE OF THE PRODUCTS
RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE±0.05

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 Town Cixi Ningbo China
 C:315333

GENERAL TOLERANCE	ANGLE TOLERANCE	PROJECTION		TITLE	Micro SIM Card H=1.35mm 6 Positions SMT Type
X. ±0.60	X. ±5°	UNITS	mm	SHEET SIZE	A4
.X ±0.38	.X ±3°	SHEET SIZE	A4	SERIES	DS1138-11 SERIES
.XX ±0.25	.XX ±2°	晨翔电子有限公司 CONNFLY® CONNFLY ELECTRONIC CO., LTD			
DRAWING TYPE	CUSTOMER				
SCALE	1:1 SHEET 1 OF 1				
DRAWING NO.	C-DS1138-11-XXXXXXX-A				